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PACMNET, V1, N2, September 2023 Editorial

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The Proceedings of the ACM series present the highest-quality research conducted in diverse areas of computer science, as represented by the ACM Special Interest Groups (SIGs). PACMNET focuses on contributions presenting significant and novel research results on emerging computer networks and their applications.

PACMNET collects top-quality scholarly articles in the area of computer networking. We encourage submissions that present new technologies, novel experimentation, creative use of networking technologies, and new insights made possible using analysis. The journal is strongly supported by the ACM Special Interest Group on Communications and Computer Networks (SIGCOMM) and involves top-level researchers in its Editorial Board.

The papers have been selected by the 50 Associate Editors following a rigorous review process. After review, each paper was conditionally accepted (with shepherding), allowed a "one-shot-major" revision, or rejected. The review process was split into two rounds. All submissions received at least 3 reviews in the first round. Those papers that advanced to the second round received at least two additional reviews. After an online discussion phase among the reviewers, papers were extensively discussed during an online Associate Editors' meeting where the final decisions were made. In case of major revision, the authors have been invited to address the reviewers' comments and prepare a thoroughly revised version of their contribution. Revised papers have been then thoroughly reviewed again before being either accepted or rejected. This issue collects papers that have been finally accepted for publication after going through the major revision process.

All papers of this PACMNET issue will be presented at the CoNEXT 2023 conference on December 5-8, in Paris, France.

We would like to thank the many individuals that contributed to this issue of PACMNET, in particular the authors, who submitted their best work to PACMNET, and the Associate Editors, who provided constructive feedback to the authors in their reviews, participated in the online discussions and the Editors' meeting. We are also grateful to the SIGCOMM Executive Committee Chair, and the CoNEXT Steering Committee members, who provided a wealth of information and guidance.

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